

767114-6 ✓ ACTIVE

MICTOR

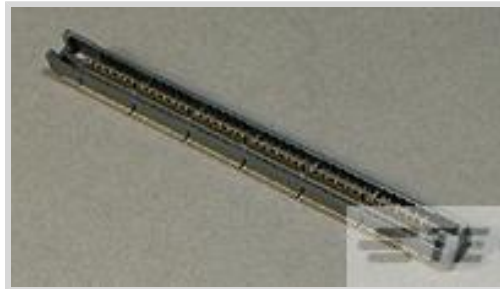
TE Internal #: 767114-6

PCB Mount Receptacle, Vertical, Board-to-Board, 228 Position, .64 mm [.025 in] Centerline, Fully Shrouded, Gold Flash over Palladium Nickel / Gold

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **228**

Centerline (Pitch): **.64 mm [.025 in]**

Features

Product Type Features

Ground Component Type	Ground Bus
PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Power Positions	6
Number of Columns	114
Stackable	No
Number of Signal Positions	228
PCB Mount Orientation	Vertical
Number of Positions	228
Board-to-Board Configuration	Parallel

Electrical Characteristics

Insulation Resistance	2 MΩ
Impedance	50 Ω
Operating Voltage	30 VAC



Signal Characteristics

Differential Signaling	Yes
Data Rate	10 Gb/s

Body Features

Primary Product Color	Black
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Contact Features

Contact Layout	Inline
	150 – 250 μ m
Contact Shape & Form	Dual Beam
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold, Gold Flash over Palladium Nickel
Contact Mating Area Plating Material Thickness	.76 μ m[30 μ m]
Contact Type	Socket
Contact Current Rating (Max)	11.5 A

Termination Features

Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.53 mm[.021 in]
Termination Method to Printed Circuit Board	Surface Mount

Mechanical Attachment

PCB Mount Alignment Type	Locating Posts
Mating Retention	With
Mating Alignment	With
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Bottom
Centerline (Pitch)	.64 mm[.025 in]
Housing Material	Liquid crystal polymer(LCP)

Dimensions



Connector Length	88.9 mm[3.5 in]
Connector Height	6 mm[.236 in]
Connector Width	6.9 mm[.272 in]
Stack Height	6.6 mm, 9 mm, 10.92 mm, 12.57 mm, 17.96 mm, 18.75 mm, 20 mm, 22.86 mm[.9 in]
PCB Thickness (Recommended)	1.57 mm[.8 in]

Usage Conditions

Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
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Operation/Application

Assembly Process Feature	Vacuum Cover
Circuit Application	Signal

Industry Standards

UL Rating	Listed
Agency/Standard	CSA, UL
Approved Standards	CSA 1195944, UL E28476
UL Flammability Rating	UL 94V-0

Packaging Features

Packaging Quantity	252
Packaging Type	Pocket Tape

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Pb (40% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

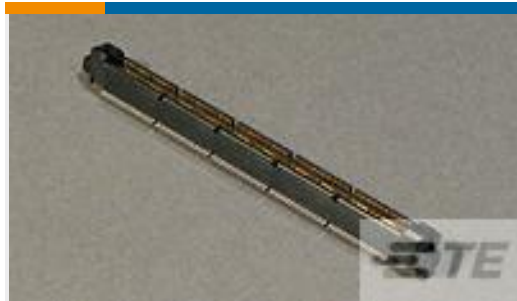
Solder Process Capability

Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 1-767007-3
[MICT,260PLUG,228,ASSY,.025,REC](#)

Documents

Product Drawings

[MICT,REC,228,ASY,.025,TAPE,CAP](#)

English

CAD Files

[3D PDF](#)

3D

Customer View Model

[ENG_CVM_CVM_767114-6_C.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_767114-6_C.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_767114-6_C.3d_stp.zip](#)

English

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Product Specifications

[Application Specification](#)

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PCB Mount Receptacle, Vertical, Board-to-Board, 228 Position, .64 mm [.025 in]
Centerline, Fully Shrouded, Gold Flash over Palladium Nickel / Gold



English